

STP4N150 STW4N150

N-channel 1500V - 5Ω - 4A - TO-220/TO-247 Very high PowerMESH™ Power MOSFET

General features

Туре	Type V _{DSS} (@Tjmax)		I _D
STP4N150	1500 V	< 7 Ω	4A
STW4N150	1500 V	< 7 Ω	4A

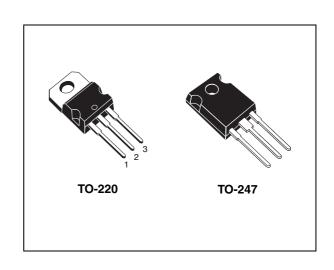
- Avalanche ruggedness
- Gate charge minimized
- Very low intrinsic capacitances
- High speed switching

Description

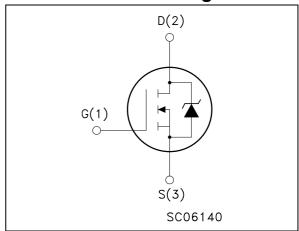
Using the well consolidated high voltage MESH OVERLAY™ process, STMicroelectronics has designed an advanced family of Power MOSFETs with outstanding performances. The strengthened layout coupled with the Company's proprietary edge termination structure, gives the lowest RDS(on) per area, unrivalled gate charge and switching characteristics.

Applications

■ Switching application



Internal schematic diagram



Order codes

Part number	Marking	Package	Packaging
STP4N150	P4N150	TO-220	Tube
STW4N150	W4N150	TO-247	Tube

Contents STP4N150 - STW4N150

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STP4N150 - STW4N150 Electrical ratings

1 Electrical ratings

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	1500	V
V _{DGR}	Drain-gate voltage (R_{GS} = 20 kΩ)	1500	V
V _{GS}	Gate- source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25°C	4	Α
I _D	Drain current (continuous) at T _C = 100°C	2.5	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	12	Α
P _{TOT}	Total dissipation at T _C = 25°C	160	W
	Derating factor	1	W/°C
T _j T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} Pulse width limited by safe operating area

Table 2. Thermal data

Symbol	Parameter	Valu	е	Unit
		TO-220	TO-247	
Rthj-case	Thermal resistance junction-case max	0.78		°C/W
Rthj-amb	Thermal resistance junction-ambient max	pient max 62.5 50		

Table 3. Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_j max)	4	А
E _{AS}	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	350	mJ

2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Parameter Test conditions		Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	I _D = 1 mA, V _{GS} = 0	1500			V
I _{DSS}	Zero gate voltage Drain current (V _{GS} = 0)	V_{DS} = Max Rating V_{DS} = Max Rating, T_{C} = 125°C			10 500	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 30 V			± 100	μА
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	3	4	5	V
R _{DS(on}	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}$		5	7	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
g _{fs} ⁽¹⁾	Forward transconductance	$V_{DS} = 30 \text{ V}, I_{D} = 2 \text{ A}$		3.5		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$		1300 120 12		pF pF pF
$T_{d(on)}$ T_{r} $t_{d(off)}$ t_{f}	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 750 \text{ V, } I_{D} = 2 \text{ A,}$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 18)		35 30 45 45		ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 600 \text{ V}, I_{D} = 4 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see Figure 19)		30 10 9	50	nC nC nC

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)				4 12	A A
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 4 A, V _{GS} = 0			2	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 4$ A, di/dt = 100 A/ μ s $V_{DD} = 45V$ (see Figure 18)		510 3 12		ns μC Α
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 4 A, di/dt = 100 A/ μ s V_{DD} = 45V, T_j = 150°C (see Figure 18)		615 4 12.6		ns μC Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300µs, duty cycle 1.5%

2.1 Electrical characteristics (curves)

Figure 1. Safe operating area for TO-220

Figure 2. Thermal impedance for TO-220

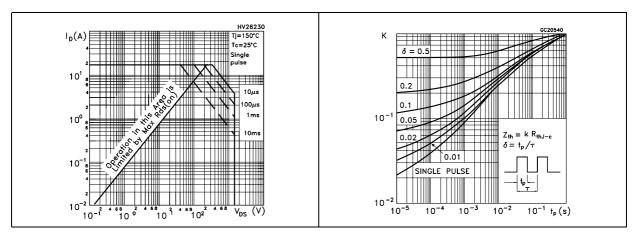


Figure 3. Safe operating area for TO-247

Figure 4. Thermal impedance for TO-247

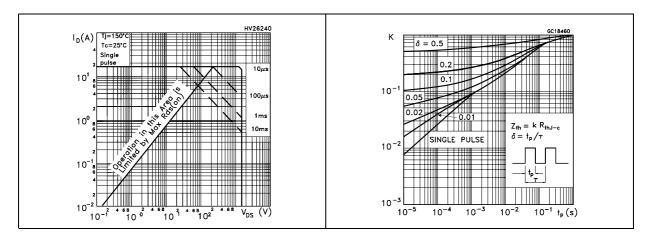


Figure 5. Output characterisics

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Figure 6. Transfer characteristics

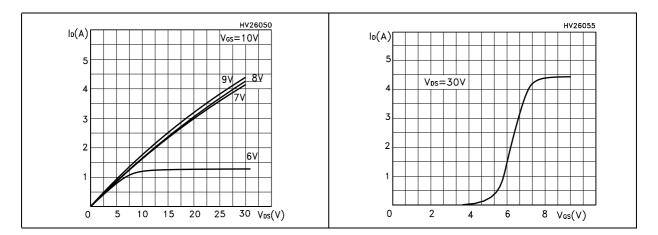


Figure 7. Transconductance

Figure 8. Static drain-source on resistance

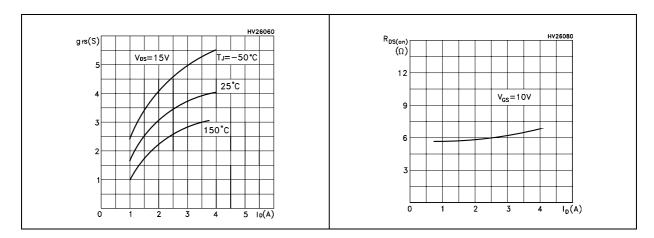


Figure 9. Gate charge vs gate-source voltage Figure 10. Capacitance variations

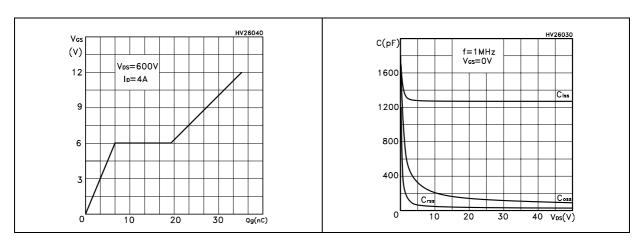
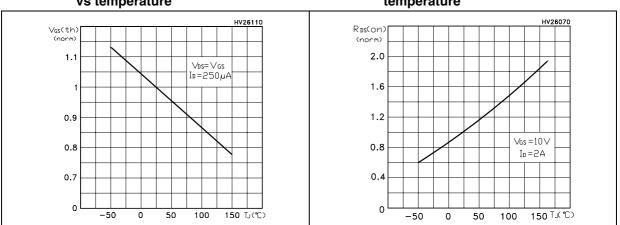


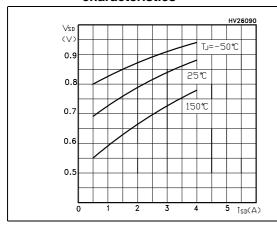
Figure 11. Normalized gate threshold voltage Figure 12. Normalized on resistance vs vs temperature temperature



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Figure 13. Source-drain diode forward characteristics

Figure 14. Normalized $\ensuremath{B_{VDSS}}$ vs temperature



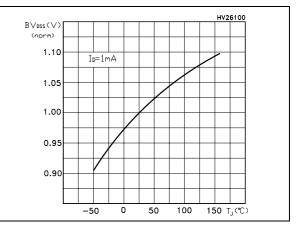
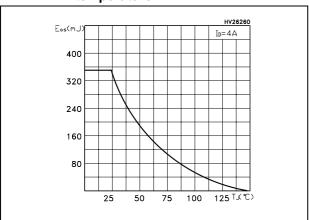


Figure 15. Maximum avalanche energy vs temperature



3 Test circuit Package mechanical data

Figure 16. Unclamped inductive load test circuit

Figure 17. Unclamped inductive waveform

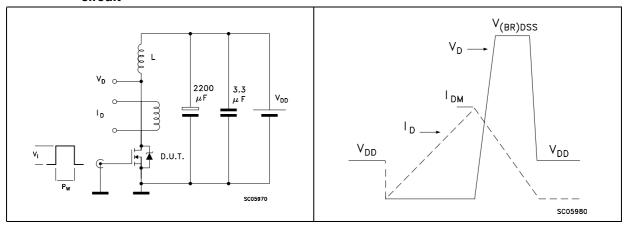


Figure 18. Switching times test circuit for resistive load

Figure 19. Gate charge test circuit

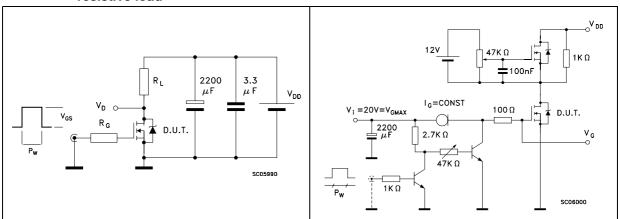
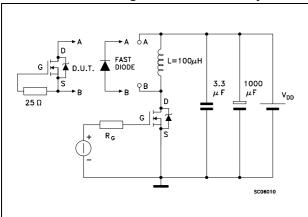


Figure 20. Test circuit for inductive load switching and diode recovery times



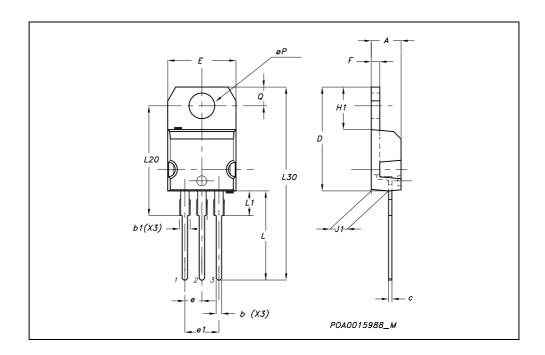
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

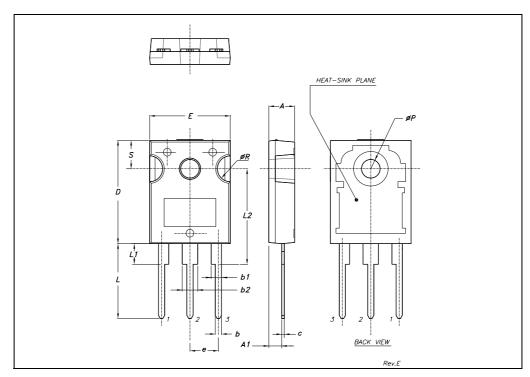
TO-220 MECHANICAL DATA

DIM.		mm.			inch	
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.40		4.60	0.173		0.181
b	0.61		0.88	0.024		0.034
b1	1.15		1.70	0.045		0.066
С	0.49		0.70	0.019		0.027
D	15.25		15.75	0.60		0.620
E	10		10.40	0.393		0.409
е	2.40		2.70	0.094		0.106
e1	4.95		5.15	0.194		0.202
F	1.23		1.32	0.048		0.052
H1	6.20		6.60	0.244		0.256
J1	2.40		2.72	0.094		0.107
L	13		14	0.511		0.551
L1	3.50		3.93	0.137		0.154
L20		16.40			0.645	
L30		28.90			1.137	
øΡ	3.75		3.85	0.147		0.151
Q	2.65		2.95	0.104		0.116



TO-247 MECHANICAL DATA

DIM		mm.			inch	
DIM.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
Α	4.85		5.15	0.19		0.20
A1	2.20		2.60	0.086		0.102
b	1.0		1.40	0.039		0.055
b1	2.0		2.40	0.079		0.094
b2	3.0		3.40	0.118		0.134
С	0.40		0.80	0.015		0.03
D	19.85		20.15	0.781		0.793
E	15.45		15.75	0.608		0.620
е		5.45			0.214	
L	14.20		14.80	0.560		0.582
L1	3.70		4.30	0.14		0.17
L2		18.50			0.728	
øΡ	3.55		3.65	0.140		0.143
øR	4.50		5.50	0.177		0.216
S		5.50			0.216	



STP4N150 - STW4N150 Revision history

5 Revision history

Table 7. Revision history

Date	Revision	Changes
29-Mar-2005	1	First release
07-Jul-2005	2	Removed TO-220FP
07-Oct-2005	3	Complete version
10-Aug-2006	4	New template, no content change

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